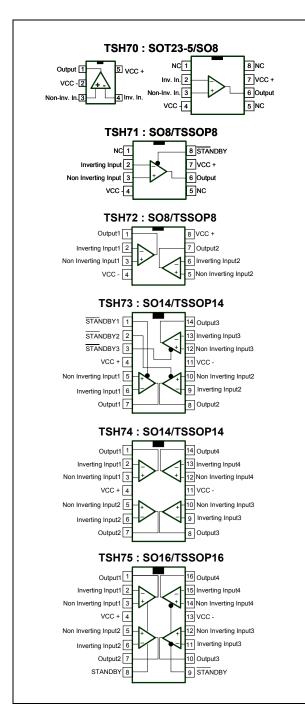


# TSH70, TSH71, TSH72, TSH73, TSH74, TSH75

Rail-to-rail, wide-band, low-power operational amplifiers



### Features

- 3 V, 5 V, ±5 V specifications
- 3 dB bandwidth: 90 MHz
- Gain bandwidth product: 70 MHz
- Slew rate: 100 V/µs (typical for 5 V)

**Datasheet - production data** 

- Output current: up to 55 mA
- Input single supply voltage
- Output rail-to-rail
- Specified for 150  $\Omega$  loads
- Low distortion, THD: 0.1 %
- SOT23-5, TSSOP, and SO packages

### Applications

- Video buffers
- ADC driver
- Hi-fi applications

### Description

The TSH7x series offers single, dual, triple, and quad operational amplifiers featuring high video performances with large bandwidth, low distortion, and excellent supply voltage rejection. Running with a single supply voltage from 3 V to 12 V, these amplifiers feature a large output voltage swing and high output current capable of driving standard 150  $\Omega$  loads. A low operating voltage makes TSH7x amplifiers ideal for use in portable equipment. The TSH71, TSH73, and TSH75 also feature standby inputs, each of which allows the op-amp to be put into a standby mode with low-power consumption and high-output impedance. This function allows power saving or signal switching/multiplexing for high-speed applications and video applications. To economize both board space and weight, the TSH7x series is proposed in SOT23-5, SO, and TSSOP packages.

#### December 2013

DocID7502 Rev 4

This is information on a product in full production.

## Contents

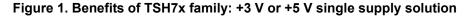
1	Туріс	al application: video driver 3
2	Abso	lute maximum ratings and operating conditions
3	Elect	rical characteristics
	3.1	Standby mode
	3.2	Characteristic curves for $V_{CC}$ = 3 V
	3.3	Characteristic curves for $V_{CC}$ = 5 V
	3.4	Characteristic curves for $V_{CC}$ = 10 V
4	Testir	ng conditions
	4.1	Layout precautions 21
	4.2	Maximum input level
	4.3	Video capabilities
	4.4	Precautions when operating on an asymmetrical supply 24
5	Packa	age information
	5.1	SOT23-5 package information 27
	5.2	SO8 package information 28
	5.3	TSSOP8 package information 29
	5.4	SO14 package information 30
	5.5	TSSOP14 package information
	5.6	SO16 package information 32
	5.7	TSSOP16 package information
6	Orde	r information
7	Revis	ion history

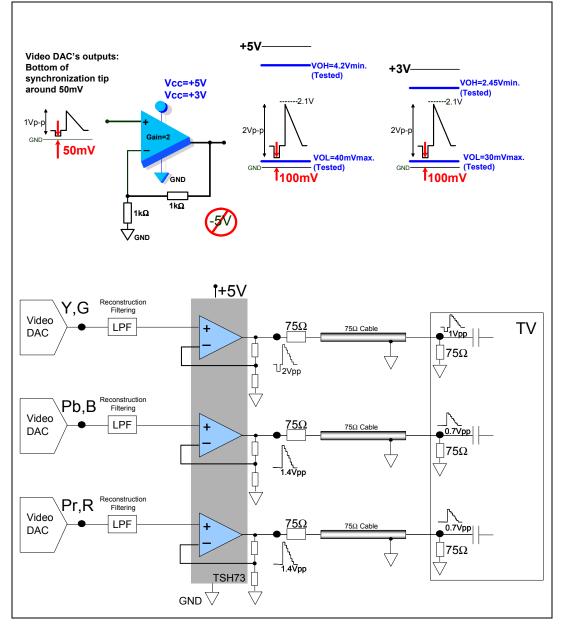


### 1 Typical application: video driver

A typical application for the TSH7x family is that of a video driver for driving STi7xxx DAC outputs on 75-ohm lines.

Figure 1 show the benefits of the TSH7x family as single supply drivers.







## 2 Absolute maximum ratings and operating conditions

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage <sup>(1)</sup>	14	
V <sub>id</sub>	Differential Input Voltage (2)	±2	V
Vi	Input Voltage <sup>(3)</sup>	±6	
T <sub>oper</sub>	Operating Free Air Temperature Range	0 to +70	
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
Тj	Maximum Junction Temperature	150	
R <sub>thjc</sub>	Thermal resistance junction to case <sup>(4)</sup> SOT23-5 SO8 TSSOP08 SO14 TSSOP14 SO16 TSSOP16	80 28 37 22 32 35 35 35	°C/W
R <sub>thja</sub>	Thermal resistance junction to ambient area SOT23-5 SO8 TSSOPO8 SO14 TSSOP14 SO16 TSSOP16	250 157 130 125 110 110 110	0,00
ESD	Human body model	2	kV

Table 1	Absolute	maximum	ratings	(AMR)
	Absolute	maximum	raungs	

1. All voltages values, except differential voltage are with respect to the network ground terminal

2. Differential voltages are the non-inverting input terminal with respect to the inverting terminal

3. The magnitude of the input and output must never exceed  $V_{CC}$  +0.3V

4. Short-circuits can cause excessive heating

#### Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	3 to 12	
V <sub>IC</sub>	Common mode input voltage range	$V_{CC}^{-}$ to ( $V_{CC}^{+}$ -1.1)	V
Standby		$(V_{CC}^{-})$ to $(V_{CC}^{+})$	



#### **Electrical characteristics** 3

Table 3. $V_{CC}^+$ = 3 V, $V_{CC}^-$ = GND, $V_{IC}$ = 1.5 V, $T_{amb}$ = 25 °C (unless otherwise specified)								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
V <sub>io</sub>	Input offset voltage	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		1.2	10 12	mV		
$\Delta V_{io}$	Input offset voltage drift vs. temp.	T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		4		μV/°C		
I <sub>io</sub>	Input offset current	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		0.1	3.5 5	μA		
I <sub>ib</sub>	Input bias current	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		6	15 20	μΛ		
C <sub>in</sub>	Input capacitance			0.2		pF		
I <sub>CC</sub>	Supply current per operator	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		7.2	9.8 11	mA		
CMRR	Common mode rejection ratio (δV <sub>IC</sub> /δVio)	+0.1 < $V_{IC}$ <+1.9 V and $V_{out}$ = 1.5 V T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	65 64	90				
SVRR	Supply voltage rejection ratio (δVCC/δVio)	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	66 65	74		dB		
PSRR	Power supply rejection ratio (δVCC/δV <sub>out</sub> )	Positive and negative rail		75		ŭĎ		
A <sub>vd</sub>	Large signal voltage gain	$ \begin{array}{l} R_{L} = 150 \; \Omega  \text{to} \; 1.5 \; V, \; V_{out} = 1 \; V \; \text{to} \; 2 \; V \\ T_{amb} = 25 \; ^{\circ} C \\ T_{min.} < T_{amb} < T_{max.} \end{array} $	70 65	81				
I <sub>o</sub>	Output short circuit current source	$\begin{array}{l} T_{amb}{=}25\ ^{\circ}C, \\ V_{id}{=}+1, \ V_{out} \ to \ 1.5 \ V, \\ V_{id}{=}-1, \ V_{out} \ to \ 1.5 \ V \\ &   \text{Source} \\ &   \text{Sink} \\ T_{min.} < T_{amb} < T_{max.} \\ V_{id}{=}+1, \ V_{out} \ to \ 1.5 \ V \\ V_{id}{=}-1, \ V_{out} \ to \ 1.5 \ V \\ &   \text{Source} \\ &   \text{Source} \\ &   \text{Sink} \end{array}$	30 20 22 19	43 33		mA		
V <sub>OH</sub>	High level output voltage	$\begin{split} T_{amb} &= 25 \ ^\circ C \\ R_{L} &= 150 \ \Omega \ \text{to} \ GND \\ R_{L} &= 600 \ \Omega \ \text{to} \ GND \\ R_{L} &= 2 \ k \Omega \ \text{to} \ GND \\ R_{L} &= 2 \ k \Omega \ \text{to} \ GND \\ R_{L} &= 10 \ k \Omega \ \text{to} \ GND \\ R_{L} &= 100 \ \Omega \ to \ 1.5 \ V \\ R_{L} &= 600 \ \Omega \ to \ 1.5 \ V \\ R_{L} &= 2 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \\ R_{L} &= 10 \ k \Omega \ to \ 1.5 \ V \end{split}$	2.45 2.65 2.4 2.6	2.60 2.87 2.91 2.93 2.77 2.90 2.92 2.93		V		



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
		$T_{amb} = 25 \text{ °C}$ $R_{L} = 150 \Omega \text{ to GND}$ $R_{L} = 600 \Omega \text{ to GND}$ $R_{L} = 2  k\Omega \text{ to GND}$ $R_{L} = 10  k\Omega \text{ to GND}$		10 11 11 11	30	
V <sub>OL</sub>	Low level output voltage	$R_{L} = 150 \Omega \text{ to } 1.5 \text{ V}$ $R_{L} = 600 \Omega \text{ to } 1.5 \text{ V}$ $R_{L} = 2 k\Omega \text{ to } 1.5 \text{ V}$ $R_{L} = 10 k\Omega \text{ to } 1.5 \text{ V}$		140 90 68 57	300	mV
V <sub>OL</sub> Low level output vol         GBP       Gain bandwidth pro         Bw       Bandwidth @-3dB         SR       Slew rate         φm       Phase margin         en       Equivalent input noi         THD       Total harmonic distor         IM2       Second order interm         IM2       Second order interm         ΔG       Differential gain         Df       Differential phase         Gf       Gain flatness		T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub> R <sub>L</sub> = 150 Ω to GND R <sub>L</sub> = 150 Ω to 1.5 V			40 350	
GBP	Gain bandwidth product	F = 10 MHz A <sub>VCL</sub> = +11 A <sub>VCL</sub> = -10		65 55		MHz
Bw	Bandwidth @-3dB	A <sub>VCL</sub> =+1, R <sub>L</sub> =150 $\Omega$ to 1.5 V		87		
SR	Slew rate	$A_{VCL}$ =+2, R <sub>L</sub> =150 Ω// C <sub>L</sub> to 1.5 V C <sub>L</sub> = 5 pF C <sub>L</sub> = 30 pF	45	80 85		V/µs
φm	Phase margin	R <sub>L</sub> =150 $\Omega$ // 30 pF to 1.5 V		40		0
en	Equivalent input noise voltage	F=100 kHz		11		nV/∖Hz
THD	Total harmonic distortion	$A_{VCL} = +2, F = 4 \text{ MHz}, R_L = 150 \Omega //$ 30  pF to  1.5  V $V_{out} = 1 \text{ Vpp}$ $V_{out} = 2 \text{ Vpp}$		-61 -54		dB
IM2	Second order intermodulation product	$\begin{array}{l} A_{\text{VCL}} = +2,  V_{\text{out}} = 2  \text{Vpp} \\ R_{\text{L}} = 150  \Omega  \text{to}  1.5  \text{V} \\ Fin1 = 180  \text{kHz},  Fin2 = 280  \text{kHz} \\ spurious measurements @100  \text{kHz} \end{array}$		-76		dBc
IM3	Third order inter modulation product	$A_{VCL}$ = +2, $V_{out}$ = 2 Vpp $R_L$ = 150 $\Omega$ to 1.5 V Fin1 = 180kHz, Fin2 = 280 kHz spurious measurements @400 kHz		-68		UDC
ΔG	Differential gain	$A_{VCL}$ =+2, R <sub>L</sub> = 150 Ωto 1.5 V F = 4.5 MHz, V <sub>out</sub> = 2 Vpp		0.5		%
Df	Differential phase	$A_{VCL}$ = +2, R <sub>L</sub> = 150 $\Omega$ to 1.5 V F = 4.5 MHz, V <sub>out</sub> = 2 Vpp		0.5		o
Gf	Gain flatness	F = DC to 6 MHz, $A_{VCL}$ = +2		0.2		dB
Vo1/Vo2	Channel separation	F = 1 MHz to 10 MHz		65		GD

Table 3.	$V_{CC}^{+} = 3 V, V_{CC}^{-}$	= GND, V <sub>IC</sub> = 1	.5 V, T <sub>amb</sub> =	25 °C	(unless otherw	ise sp	ecifie	d) (cor	ntinued)
	_		_				_		



Symbol	bol Parameter Test conditions		Min.	Тур.	Max.	Unit	
V <sub>io</sub>	Input offset voltage	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		1.1	10 12	mV	
$\Delta V_{io}$	Input offset voltage drift vs. temp.	T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		3		μV/°C	
I <sub>io</sub>	Input offset current	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		0.1	3.5 5	μA	
I <sub>ib</sub>	Input bias current	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		6	15 20	μυτ	
C <sub>in</sub>	Input capacitance			0.3		pF	
I <sub>CC</sub>	Supply current per operator	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		8.2	10.5 11.5	mA	
CMRR	Common mode rejection ratio (ðV <sub>IC</sub> /ðVio)	+0.1 < $V_{IC}$ < 3.9 V and $V_{out}$ = 2.5 V T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	72 71	97			
SVRR	Supply voltage rejection ratio $(\delta V_{CC}/\delta V_{IO})$	T <sub>amb</sub> = 25°C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	68 67	75			
PSRR	Power supply rejection ratio $(\delta V_{CC}/\delta V_{out})$	Positive and negative rail		75		dB	
A <sub>vd</sub>	Large signal voltage gain		75 70	84			
Io	Output short circuit current source	$\begin{array}{l} T_{amb} = 25 \ ^{\circ}\text{C}, \\ V_{id} = +1, \ V_{out} \ \text{to} \ 1.5 \ \text{V}, \\ V_{id} = -1, \ V_{out} \ \text{to} \ 1.5 \ \text{V} \\ \hline \\ \text{ISource} \\ \text{Isink} \\ T_{min.} < T_{amb} < T_{max.} \\ V_{id} = +1, \ V_{out} \ \text{to} \ 1.5 \ \text{V} \\ V_{id} = -1, \ V_{out} \ \text{to} \ 1.5 \ \text{V} \\ \hline \\ \text{ISource} \\ \hline \\ \text{ISource} \\ \hline \\ \text{Isink} \end{array}$	35 33 34 32	55 55		mA	
V <sub>OH</sub>	High level output voltage	$T_{amb} = 25 \text{ °C}$ $R_{L} = 150 \Omega \text{ to GND}$ $R_{L} = 600 \Omega \text{ to GND}$ $R_{L} = 2 k\Omega \text{ to GND}$ $R_{L} = 10 k\Omega \text{ to GND}$ $R_{L} = 150 \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 600 \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 2 k\Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 k\Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 k\Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 \Omega \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 \Omega \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 \Omega \Omega \text{ to } 2.5 \text{ V}$	4.2 4.5 4.1 4.4	4.36 4.85 4.90 4.93 4.66 4.90 4.92 4.93		v	

Table 4.  $V_{CC}^+$  = 5 V,  $V_{CC}^-$  = GND,  $V_{IC}$  = 2.5 V,  $T_{amb}$  = 25 °C (unless otherwise specified)



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
		$\begin{array}{l} T_{amb}{=}25 \ ^{\circ}\text{C} \\ R_{L} = 150 \ \Omega \ \text{to} \ \text{GND} \\ R_{L} = 600 \ \Omega \ \text{to} \ \text{GND} \\ R_{L} = 2 \ \text{k}\Omega \ \text{to} \ \text{GND} \\ R_{L} = 10 \ \text{k}\Omega \ \text{to} \ \text{GND} \end{array}$		20 23 23 23	40	
V <sub>OL</sub>	Low level output voltage	$R_{L} = 150 \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 600 \Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 2 k\Omega \text{ to } 2.5 \text{ V}$ $R_{L} = 10 k\Omega \text{ to } 2.5 \text{ V}$		220 105 76 61	400	mV
	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	60 450				
GBP	Gain bandwidth product	A <sub>VCL</sub> = +11				MHz
Bw	Bandwidth @-3 dB	$A_{VCL}$ = +1, $R_L$ = 150 $\Omega$ to 2.5 V		87		
SR	Slew rate	$R_L = 150\Omega // C_L \text{ to } 2.5 \text{ V}$ $C_L = 5 \text{ pF}$	60			V/µs
φm	Phase margin	$R_L$ = 150 $\Omega$ // 30 pF to 2.5 V		40		0
en	Equivalent input noise voltage	F = 100 kHz		11		nV/√Hz
THD	Total harmonic distortion	$R_L = 150 \Omega // 30 \text{ pF to } 2.5 \text{ V}$ V <sub>out</sub> = 1 Vpp		-		dB
IM2		R <sub>L</sub> = 150 Ω to 2.5 V Fin1 = 180 kHz, Fin2 = 280 kHz		-76		dBc
IM3	Third order inter modulation product	R <sub>L</sub> = 150 Ω to 2.5 V Fin1 = 180 kHz, Fin2 = 280 kHz		-68		ubc
ΔG	Differential gain	$F = 4.5 \text{ MHz}, V_{out} = 2 \text{ Vpp}$		0.5		%
Df	Differential phase			0.5		o
Gf	Gain flatness			0.2		dB
Vo1/Vo2	Channel separation	F = 1 MHz to 10 MHz		65		

Table 4.	$V_{CC}^{+} = 5 V, V_{CC}^{-} =$	= GND, V <sub>IC</sub> = 2.	5 V, T <sub>amb</sub> = 2	5 °C (unless othe	erwise sj	pecifie	d) (co	ntinued)



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>io</sub>	Input offset voltage	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		0.8	10 12	mV
$\Delta V_{io}$	Input offset voltage drift vs. temp.	T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		2		μV/°C
I <sub>io</sub>	Input offset current	T <sub>amb</sub> = 25°C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		0.1	3.5 5	μA
I <sub>ib</sub>	Input bias current	T <sub>amb</sub> = 25°C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		6	15 20	μΛ
C <sub>in</sub>	Input capacitance			0.7		pF
I <sub>CC</sub>	Supply current per operator	T <sub>amb</sub> = 25°C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>		9.8	12.3 13.4	mA
CMRR	Common mode rejection ratio (ðV <sub>IC</sub> /ðVio)	-4.9 < $V_{IC}$ < 3.9 V and $V_{out}$ = GND T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	81 80	106		
SVRR	Supply voltage rejection ratio $(\delta V_{CC}/\delta V_{io})$	T <sub>amb</sub> = 25 °C T <sub>min.</sub> < T <sub>amb</sub> < T <sub>max.</sub>	71 70	77		
PSRR	Power supply rejection ratio $(\delta V_{CC}/\delta V_{out})$	Positive and negative rail		75		dB
A <sub>vd</sub>	Large signal voltage gain	$ \begin{array}{l} R_{L} = 150 \ \Omega \ \text{to} \ GND \\ V_{out} = -4 \ to + 4 \\ T_{amb} = 25 \ ^{\circ}C \\ T_{min.} < T_{amb} < T_{max.} \end{array} $	75 70	86		
I <sub>o</sub>	Output short circuit current source	$\begin{split} T_{amb} &= 25 \ ^\circ C \\ V_{id} &= +1, \ V_{out} \ to \ 1.5 \ V \\ V_{id} &= -1, \ V_{out} \ to \ 1.5 \ V \\ &  Source  \\ &  Sink \\ T_{min.} < T_{amb} < T_{max.} \\ V_{id} &= +1, \ V_{out} \ to \ 1.5 \ V \\ V_{id} &= -1, \ V_{out} \ to \ 1.5 \ V \\ &  Source  \\ &  Source  \\ &  Sink \\ \end{split}$	35 30 34 29	55 55		mA
V <sub>OH</sub>	High level output voltage	$T_{amb} = 25 °C$ $R_{L} = 150 \Omega to GND$ $R_{L} = 600 \Omega to GND$ $R_{L} = 2 k\Omega to GND$ $R_{L} = 10 k\Omega to GND$ $T_{min.} < T_{amb} < T_{max.}$ $R_{L} = 150 \Omega to GND$	4.2 4.1	4.36 4.85 4.9 4.93		V
V <sub>OL</sub>	Low level output voltage	$T_{amb} = 25 °C$ $R_{L} = 150 \Omega to GND$ $R_{L} = 600 \Omega to GND$ $R_{L} = 2 k\Omega to GND$ $R_{L} = 10 k\Omega to GND$ $T_{min.} < T_{amb} < T_{max.}$ $R_{L} = 150 \Omega to GND$		-4.63 -4.86 -4.9 -4.93	-4.4 -4.3	V

Table 5.  $V_{CC}^+$  = 5 V,  $V_{CC}^-$  = -5V,  $V_{IC}$  = GND,  $T_{amb}$  = 25 °C (unless otherwise specified)



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
GBP	Gain bandwidth product	$F = 10 \text{ MHz}$ $A_{VCL} = +11$ $A_{VCL} = -10$		65 55		MHz
Bw	Bandwidth @-3dB	$A_{VCL}$ = +1 R <sub>L</sub> = 150 $\Omega$ // 30 pF to GND		100		MHz
SR	Slew rate	$A_{VCL}$ = +2, $R_L$ = 150 $\Omega$ // $C_L$ to GND $C_L$ = 5 pF $C_L$ = 30 pF	68	117 118		V/µs
φm	Phase margin	$R_L = 150 \Omega$ to GND		40		o
en	Equivalent input noise voltage	F = 100 kHz		11		nV/√Hz
THD	Total harmonic distortion	$\begin{array}{l} A_{\text{VCL}} = +2, \ F = 4 \ MHz \\ R_{\text{L}} = 150 \ \Omega  / / \ 30 \ pF \ to \ GND \\ V_{\text{out}} = 1 \ Vpp \\ V_{\text{out}} = 2 \ Vpp \end{array}$		-61 -54		dB
IM2	Second order intermodulation product	$A_{VCL}$ = +2, $V_{out}$ = 2 Vpp $R_L$ = 150 $\Omega$ to GND Fin1 = 180 kHz, Fin2 = 280 kHz spurious measurements @100 kHz		-76		dBc
IM3	Third order intermodulation product	$A_{VCL}$ = +2, $V_{out}$ = 2 Vpp $R_L$ = 150 $\Omega$ to GND Fin1 = 180 kHz, Fin2 = 280 kHz spurious measurements @400 kHz		-68		ubc
ΔG	Differential gain	$A_{VCL}$ = +2, $R_L$ = 150 $\Omega$ to GND F = 4.5 MHz, $V_{out}$ = 2 Vpp		0.5		%
Df	Differential phase	$A_{VCL}$ = +2, $R_L$ = 150 $\Omega$ to GND F = 4.5 MHz, $V_{out}$ = 2 Vpp		0.5		o
Gf	Gain flatness	F = DC to 6 MHz, $A_{VCL}$ = +2		0.2		dB
Vo1/Vo2	Channel separation	F = 1 MHz to 10 MHz		65		UD .

# Table 5. V<sub>CC</sub><sup>+</sup> = 5 V, V<sub>CC</sub><sup>-</sup> = -5V, V<sub>IC</sub> = GND, T<sub>amb</sub> = 25 °C (unless otherwise specified) (continued)



## 3.1 Standby mode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>low</sub>	Standby low level		V <sub>CC</sub> -		(V <sub>CC</sub> <sup>-</sup> +0.8)	V
V <sub>high</sub>	Standby high level		(V <sub>CC</sub> <sup>-</sup> +2)		$(V_{CC}^{+})$	
I <sub>CC STBY</sub>	Current consumption per operator when STANDBY is active	Pin 8 (TSH71) to $V_{CC}^{-1}$ Pin 1, 2 or 3 (TSH73) to $V_{CC}^{-1}$ Pin 8 (TSH75) to $V_{CC}^{+1}$ Pin 9 (TSH75) to $V_{CC}^{-1}$		20	55	μΑ
Z <sub>out</sub>	Output impedance (R <sub>out</sub> //C <sub>out</sub> )	R <sub>out</sub> C <sub>out</sub>		10 17		MΩ pF
T <sub>on</sub>	Time from standby mode to active mode			2		
T <sub>off</sub>	Time from active mode to standby mode	Down to I <sub>CC STBY</sub> = 10 μA		10		μs

Table 6. V<sub>CC</sub><sup>+</sup>, V<sub>CC</sub><sup>-</sup>, T<sub>amb</sub> = 25 °C (unless otherwise specified)

#### Table 7. TSH71 standby function table

TSH71 standby control pin 8 (STBY)	Operator status
V <sub>low</sub>	Standby
V <sub>high</sub>	Active

TS	H73 standby cont		Operator status		
Pin 1         Pin 2         Pin 3           (STBY OP1)         (STBY OP2)         (STBY OP3)			OP1	OP1	
V <sub>low</sub>	х	х	Standby	х	

х

х

 $V_{\text{low}}$ 

V<sub>high</sub>

Active

х

Х

х

х

х

Standby

Active

х

х

#### Table 8. TSH73 standby function table



V<sub>high</sub>

х

Х

х

х

х

 $V_{\text{low}}$ 

V<sub>high</sub>

х

х

OP3

х

х

х

х

Standby

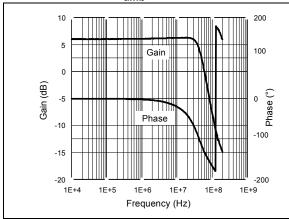
Active

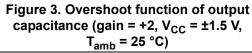
TSH75 star	dby control		Operator status							
Pin 8 (STBY OP2)	<u>Pin</u> 9 (STBY OP3)	OP1	OP2	OP3	OP4					
V <sub>high</sub>	V <sub>low</sub>		Standby	Standby						
V <sub>high</sub>	V <sub>high</sub>	Active	Standby	Active	Active					
V <sub>low</sub>	V <sub>low</sub>	Active	Active	Standby	Active					
V <sub>low</sub>	V <sub>high</sub>		Active	Active						

Table 9. TSH75 standby function table

### 3.2 Characteristic curves for V<sub>CC</sub> = 3 V

Figure 2. Closed loop gain and phase vs. frequency (gain = +2,  $V_{CC}$  = ±1.5 V,  $R_L$  = 150  $\Omega$ ,  $T_{amb}$  = 25 °C)





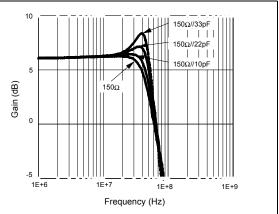
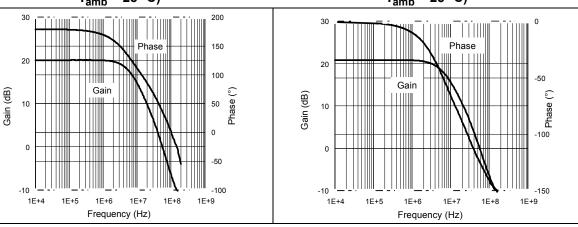


Figure 4. Closed loop gain and phase vs. frequency (gain = -10,  $V_{CC}$  = ±1.5 V,  $R_L$  = 150  $\Omega$ ,  $T_{amb}$  = 25 °C)

Figure 5. Closed loop gain and phase vs. frequency (gain = +11, V<sub>CC</sub> =  $\pm$ 1.5 V, R<sub>L</sub> = 150  $\Omega$ , T<sub>amb</sub> = 25 °C)



12/36



Figure 6. Large signal measurement positive slew rate (gain = 2,  $V_{CC}$  = ±1.5 V,  $Z_L$  = 150  $\Omega$  // 5.6 pF

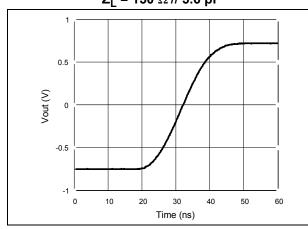


Figure 8. Small signal measurement - rise time (gain = 2,  $V_{CC}$  = ±1.5 V,  $Z_L$  = 150  $\Omega$ )

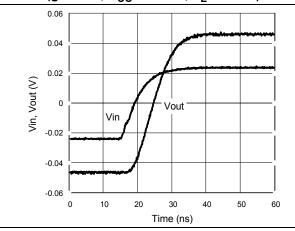


Figure 10. Channel separation (Xtalk) vs. frequency (measurement configuration: Xtalk = 20 log (V0/V1))

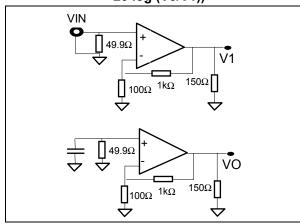


Figure 7. Large signal measurement - negative slew rate (gain = 2,  $V_{CC}$  = ±1.5 V,  $Z_{L}$  = 150  $\Omega$  // 5.6 pF)

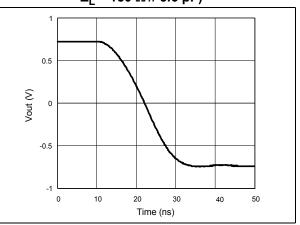


Figure 9. Small signal measurement - fall time (gain = 2,  $V_{CC}$  = ±1.5 V,  $Z_{L}$  = 150  $\Omega$ )

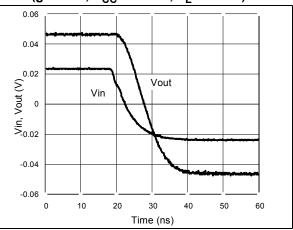
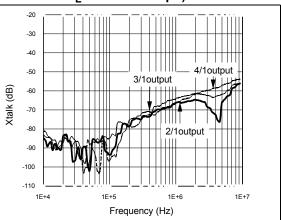


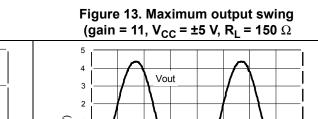
Figure 11. Channel separation (Xtalk) vs. frequency (gain = +11,  $V_{CC}$  = 1.5 V,  $Z_L$  = 150  $\Omega$  // 27 pF)



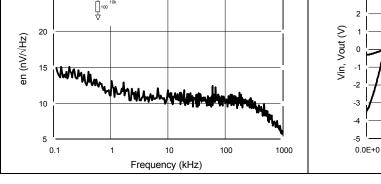
57

30

25



5.0E-2



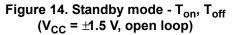


Figure 12. Equivalent noise voltage

(gain = 100, V<sub>CC</sub> = ±1.5 V, No load)

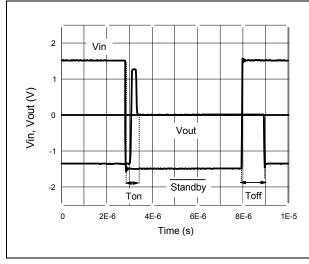


Figure 15. Group delay gain = 2 (V<sub>CC</sub> =  $\pm$ 1.5 V, Z<sub>L</sub> = 150  $\Omega$  // 27 pF, T<sub>amb</sub> = 25 °C)

1.0E-1

Time (ms)

1.5E-1

2.0E-1

Vin

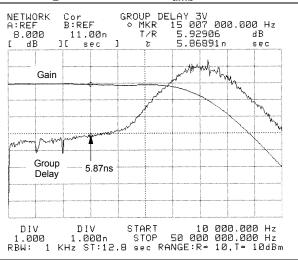
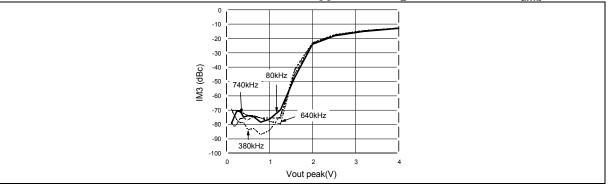


Figure 16. Third order intermodulation (gain = 2,  $V_{CC}$  = ±1.5 V,  $Z_L$  = 150  $\Omega$  // 27 pF,  $T_{amb}$  = 25 °C)



1. Note on intermodulation products:

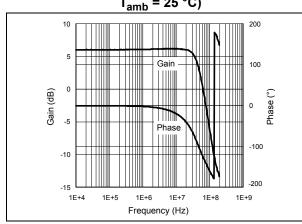
The IFR2026 synthesizer generates a two tone signal (F1 = 180 kHz, F2 = 280 kHz); each tone has the same amplitude level.

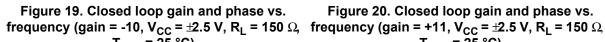
The HP3585 spectrum analyzer measures the intermodulation products function of the output voltage. The generator and the spectrum analyzer are phase locked for precision considerations.

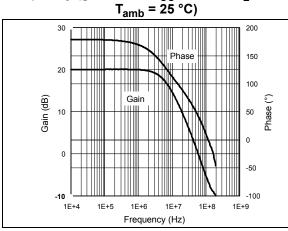


#### Characteristic curves for $V_{CC}$ = 5 V 3.3

Figure 17. Closed loop gain and phase vs. frequency (gain = +2,  $V_{CC}$  = ±2.5 V,  $R_L$  = 150  $\Omega$ ,  $T_{amb}$  = 25 °C)







T<sub>amb</sub> = 25 °C) 10 150<u>Ω</u>//33p нцін 150Q//22r 5 1500//10nE Gain (dB) 15Ó<u>s</u> 0 -5 1E+6 1E+7 1E+8 1E+9 Frequency (Hz)

Figure 18. Overshoot function of output

capacitance (gain = +2,  $V_{CC}$  = ±2.5 V,

Figure 20. Closed loop gain and phase vs. T<sub>amb</sub> = 25 °C)

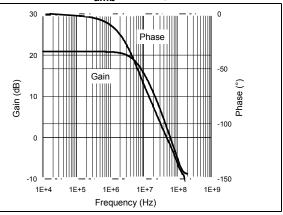


Figure 21. Large signal measurement - positive Figure 22. Large signal measurement - negative slew rate (gain = 2, V<sub>CC</sub> = ±2.5 V, Z<sub>L</sub>= 150  $\Omega$  //

slew rate (gain = 2, V<sub>CC</sub> = ±2.5 V, Z<sub>L</sub> = 150  $\Omega$  //

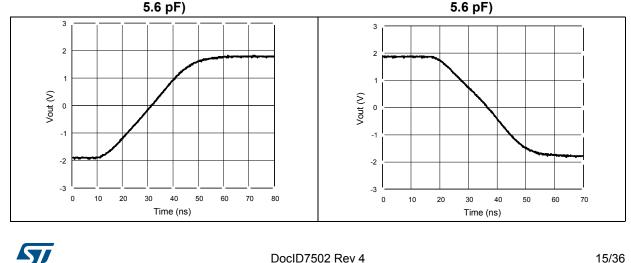


Figure 23. Small signal measurement - rise time Figure 24. Small signal measurement - fall time (gain = 2,  $V_{CC}$  = ±2.5 V,  $Z_{L}$  = 150  $\Omega$ )

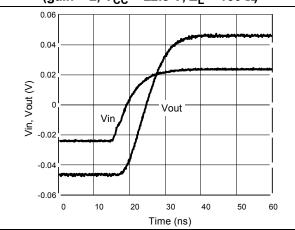


Figure 25. Channel separation (Xtalk) vs. frequency (measurement configuration: Xtalk = 20 log (V0/V1))

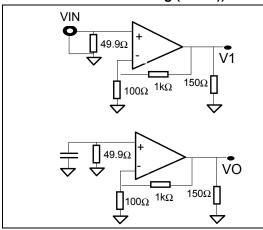
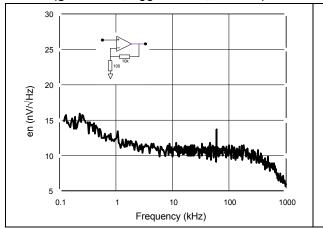


Figure 27. Equivalent noise voltage (gain = 100, V<sub>CC</sub> = ±2.5 V, no load)



(gain = 2,  $V_{CC}$  = ±2.5 V,  $Z_L$ = 150  $\Omega$ )

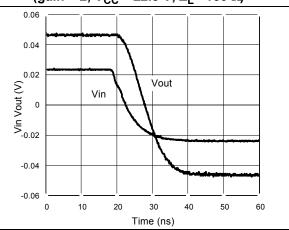


Figure 26. Channel separation (Xtalk) vs. frequency (gain = +11,  $V_{CC}$  = ±2.5 V,  $Z_L = 150 \Omega // 27 pF$ )

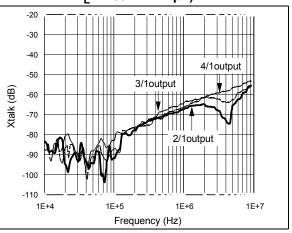
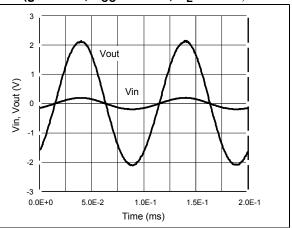


Figure 28. Maximum output swing (gain = 11,  $V_{CC}$  = ±2.5 V,  $R_L$  = 150  $\Omega$ )







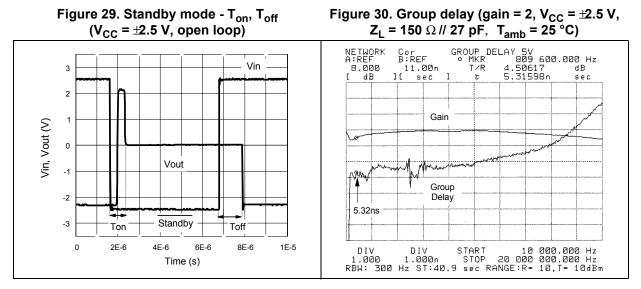
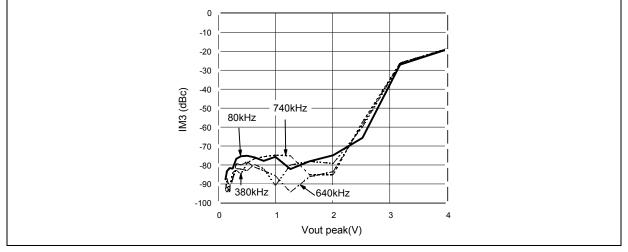


Figure 31. Third order intermodulation (gain = 2,  $V_{CC}$  = ±2.5 V,  $Z_L$  = 150  $\Omega$  // 27 pF,  $T_{amb}$  = 25 °C)



1.

Note on intermodulation products: The IFR2026 synthesizer generates a two tone signal (F1 = 180 kHz, F2 = 280 kHz); each tone has the same amplitude level.

The HP3585 spectrum analyzer measures the intermodulation products function of the output voltage. The generator and the spectrum analyzer are phase locked for precision considerations.



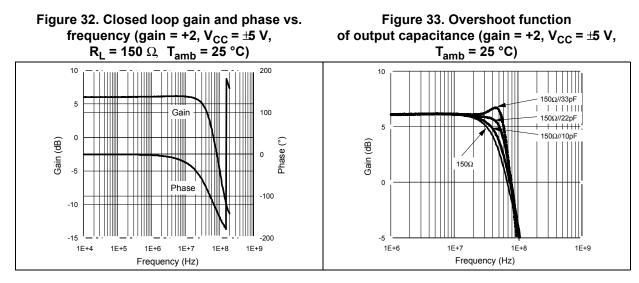


Figure 34. Closed loop gain and phase vs. frequency (gain = -10,  $V_{CC} = \pm 5 V$ ,

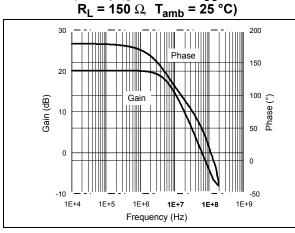


Figure 35. Closed loop gain and phase vs. frequency (gain = +11, V<sub>CC</sub> =  $\pm$ 5 V, R<sub>L</sub> = 150  $\Omega$ , T<sub>amb</sub> = 25 °C)

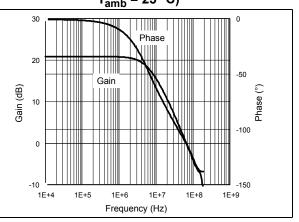
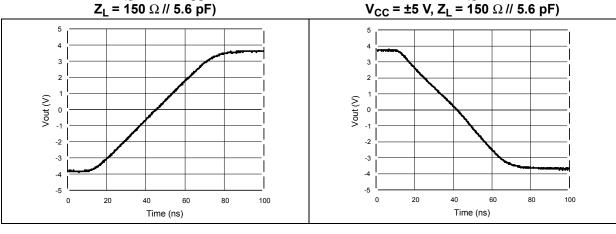


Figure 36. Large signal measurement - positive Figure 37. Large signal measurement - negative slew rate (gain = 2,V<sub>CC</sub> = ±5 V, slew rate (gain = 2





18/36

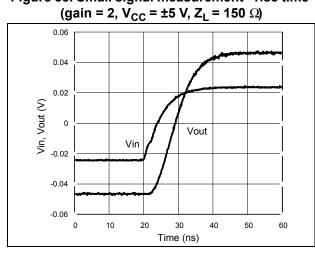


Figure 40. Channel separation (Xtalk) vs. frequency (measurement configuration: Xtalk = 20 log(V0/V1))

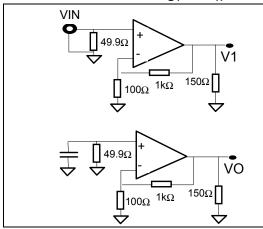


Figure 42. Equivalent noise voltage (gain = 100,  $V_{CC}$  = ±5 V, no load)

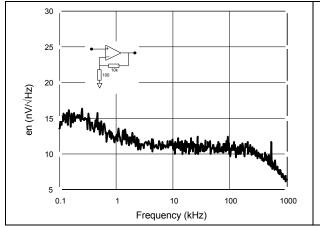


Figure 38. Small signal measurement - rise timeFigure 39. Small signal measurement - fall time(gain = 2,  $V_{CC} = \pm 5 V$ ,  $Z_L = 150 \Omega$ )(gain = 2,  $V_{CC} = \pm 5 V$ ,  $Z_L = 150 \Omega$ )

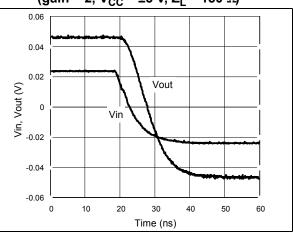


Figure 41. Channel separation (Xtalk) vs. frequency (gain = +11,  $V_{CC}$  =  $\pm 5$  V,  $Z_L$  = 150  $\Omega$  // 27 pF)

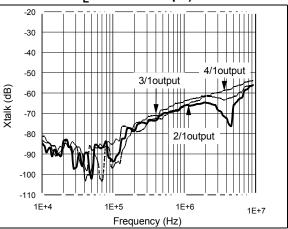
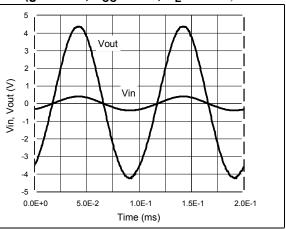


Figure 43. Maximum output swing (gain = 11,  $V_{CC}$  = ±5 V,  $R_L$  = 150  $\Omega$ )



57

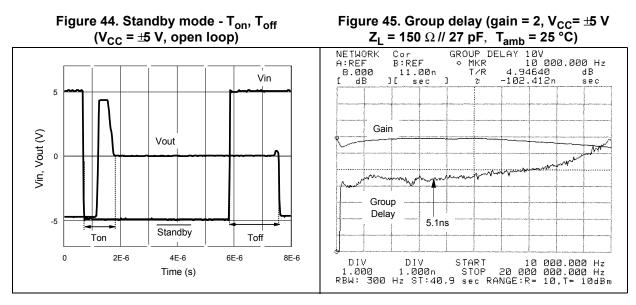
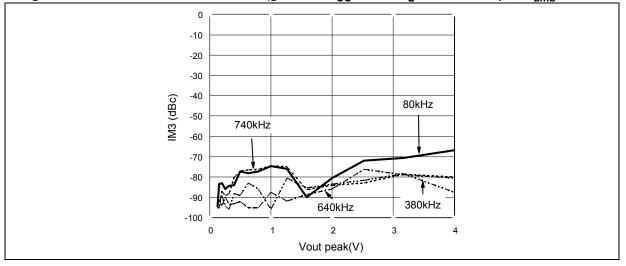


Figure 46. Third order intermodulation (gain = 2, V<sub>CC</sub> =  $\pm$ 5 V, Z<sub>L</sub> = 150  $\Omega$  // 27 pF, T<sub>amb</sub> = 25 °C



1.

Note on intermodulation products: The IFR2026 synthesizer generates a two tone signal (F1 = 180 kHz, F2 = 280 kHz); each tone has the same amplitude level.

The HP3585 spectrum analyzer measures the intermodulation products function of the output voltage. The generator and the spectrum analyzer are phase locked for precision considerations.



### 4 Testing conditions

### 4.1 Layout precautions

To use the TSH7X circuits in the best manner at high frequencies, some precautions have to be taken for power supplies:

- First of all, the implementation of a proper ground plane on both sides of the PCB is mandatory for high-speed circuit applications to provide low inductance and low resistance common return.
- Power supply bypass capacitors (4.7 µF and ceramic 100 pF) should be placed as close as possible to the IC pins in order to improve high frequency bypassing and reduce harmonic distortion. The power supply capacitors must be incorporated for both the negative and the positive pins.
- Proper termination of all inputs and outputs must be in accordance with output termination resistors. In this way, the amplifier load is resistive only, and the stability of the amplifier is improved.
- All leads must be wide and as short as possible (especially for op-amp inputs and outputs) in order to decrease parasitic capacitance and inductance.
- For lower gain applications, care should be taken to avoid large feedback resistance (> 1 kΩ) in order to reduce the time constant of parasitic capacitances.
- Choose component sizes as small as possible (SMD)
- Finally, on output, the load capacitance must be negligible to maintain good stability. You can put a serial resistance as close as possible to the output pin to minimize capacitance.



### 4.2 Maximum input level

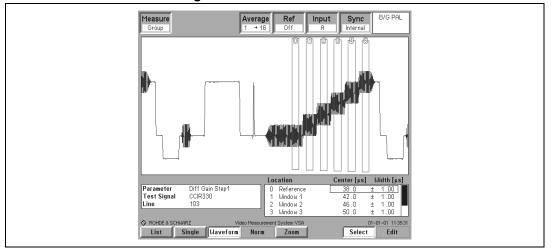


Figure 47. CCIR330 video line

The input level must not exceed the following values:

- Negative peak: must be greater than -V<sub>CC</sub>+400 mV
- Positive peak value: must be lower than +V<sub>CC</sub>-400 mV

The electrical characteristics show the influence of the load on this parameter.

### 4.3 Video capabilities

To characterize the differential phase and differential gain, a CCIR330 video line is used.

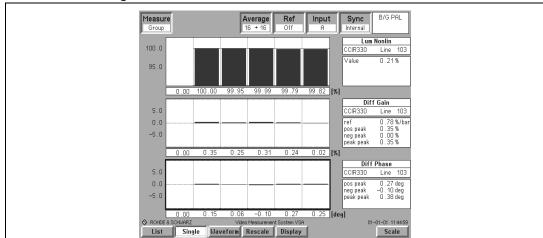
The video line contains five (flat) levels of luma on which is superimposed a chroma signal. The first level contains no luma. The luma gives various amplitudes which define the saturation of the signal. The chrominance gives various phases which define the color of the signal.

Differential phase (respectively differential gain) distortion is present if a signal chrominance phase (gain) is affected by luminance level. They represent the ability to uniformly process the high frequency information at all luminance levels.

When differential gain is present, color saturation is not correctly reproduced.

The input generator is the Rohde and Schwarz CCVS. The output measurement was made by the Rohde and Schwarz VSA.





#### Figure 48. Measurement on Rohde and Schwarz VSA

#### Table 10. Video results

Parameter	Value V <sub>CC</sub> = ±2.5 V	Value V <sub>CC</sub> = ±5 V	Unit
Lum NL	0.1	0.3	
Lum NL step 1	100	100	
Lum NL step 2	100	99.9	
Lum NL step 3	99.9	99.8	
Lum NL step 4	99.9	99.9	
Lum NL step 5	99.9	99.7	
Diff gain pos	0	0	%
Diff gain neg	-0.7	-0.6	
Diff gain pp	0.7	0.6	
Diff gain step1	-0.5	-0.3	
Diff gain step2	-0.7	-0.6	
Diff gain step3	-0.3	-0.5	
Diff gain step4	-0.1	-0.3	
Diff gain step5	-0.4	-0.5	
Diff phase pos	0	0.1	
Diff phase neg	-0.2	-0.4	
Diff phase pp	0.2	0.5	
Diff phase step1	-0.2	-0.4	dog
Diff phase step2	-0.1	-0.4	deg
Diff phase step3	-0.1	-0.3	
Diff phase step4	0	0.1	
Diff phase step5	-0.2	-0.1	



### 4.4 **Precautions when operating on an asymmetrical supply**

The TSH7X can be used with either a dual or a single supply. If a single supply is used, the inputs are biased to the mid-supply voltage ( $+V_{CC}/2$ ). This bias network must be carefully designed, in order to reject any noise present on the supply rail.

As the bias current is 15  $\mu$ A, you must carefully choose the resistance R1 so as not to introduce an offset mismatch at the amplifier inputs.

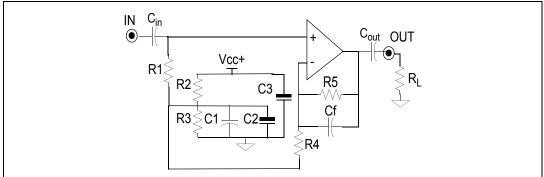
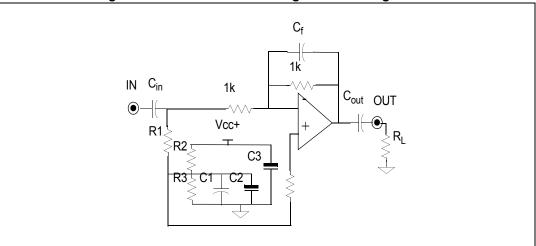


Figure 49. Schematic of asymmetrical (single) supply

R1 = 10 k $\Omega$  is a typical and convenient value. C1, C2, C3 are bypass capacitors that filter perturbations on V<sub>CC</sub>, as well as for the input and output signals. We choose C1 = 100 nF and C2 = C3 = 100  $\mu$ F.

R2, R3 are such that the current through them must be greater than 100 times the bias current. Therefore, we set R2 = R3 = 4.7 k $\Omega$ 

 $C_{in}$ , as  $C_{out}$ , is chosen to filter the DC signal by the low-pass filters (R1, $C_{in}$  and  $R_{out}$ ,  $C_{out}$ ). By taking R1 = 10 k $\Omega$ ,  $R_L$  = 150  $\Omega$ , and  $C_{in}$  = 2  $\mu$ F,  $C_{out}$  = 220  $\mu$ F we provide a cut-off frequency below 10 Hz.



#### Figure 50. Use of the TSH7x in gain = -1 configuration

Some precautions must be taken, especially for low-power supply applications.

24/36



A feedback capacitance,  $C_f$ , should be added for better stability. *Table 11* summarizes the impact of the capacitance  $C_f$  on the phase margin of the circuit.

Table 11. Impact capacitance C <sub>f</sub>										
Parameter	C <sub>f</sub> (pF)	V <sub>CC</sub> = ±1.5 V	$V_{CC}$ = $\pm 2.5 V$	V <sub>CC</sub> = ±5 V	Unit					
Phase margin	- 0	28	43	56	deg					
f-3 dB		40	39.3	38.3	MHz					
Phase margin	5.6	30	43	56	deg					
f-3 dB	- 5.0	40	39.3	38.3	MHz					
Phase margin	22	37	52	67	deg					
f-3 dB		37	34	32	MHz					
Phase margin	- 33	48	65	78	deg					
f-3 dB	_ 55	33.7	30.7	27.6	MHz					

Table 11. Impact capacitance C



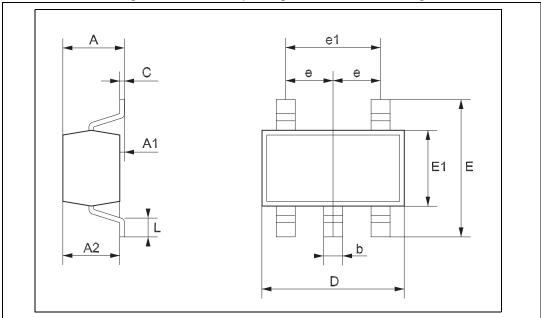
## 5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

26/36



### 5.1 SOT23-5 package information



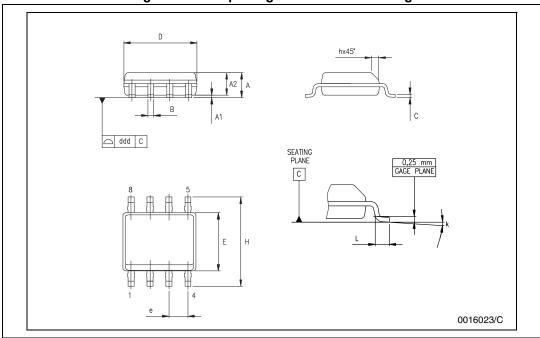
#### Figure 51. SOT23-5 package mechanical drawing

	Dimensions								
Symbol		Millimeters			Inches				
	Min	Тур	Max	Min	Тур	Max			
А	0.90		1.45	0.035		0.057			
A1	0.00		0.15	0.000		0.006			
A2	0.90		1.30	0.035		0.051			
b	0.35		0.50	0.014		0.020			
С	0.09		0.20	0.004		0.008			
D	2.80		3.00	0.110		0.118			
Е	2.60		3.00	0.102		0.118			
E1	1.50		1.75	0.059		0.069			
е		0.95			0.037				
e1		1.9			0.075				
L	0.35		0.55	0.014		0.022			

### Table 12. SOT23-5 package mechanical data



### 5.2 SO8 package information



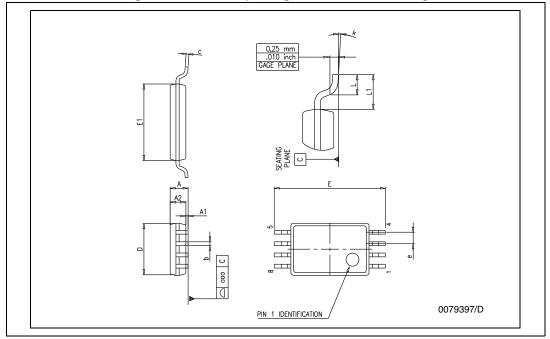
#### Figure 52. SO8 package mechanical drawing

#### Table 13. SO8 package mechanical data

	Dimensions							
Symbol	Millimeters			Inches				
	Min	Тур	Max	Min	Тур	Мах		
А	1.35		1.75	0.053		0.069		
A1	0.10		0.25	0.004		0.010		
A2	1.10		1.65	0.043		0.065		
В	0.33		0.51	0.013		0.020		
С	0.19		0.25	0.007		0.010		
D	4.80		5.00	0.189		0.197		
E	3.80		4.00	0.150		0.157		
е		1.27			0.050			
Н	5.80		6.20	0.228		0.244		
h	0.25		0.50	0.010		0.020		
L	0.40		1.27	0.016		0.050		
k			8 °			8 °		
ddd			0.1			0.004		



### 5.3 TSSOP8 package information



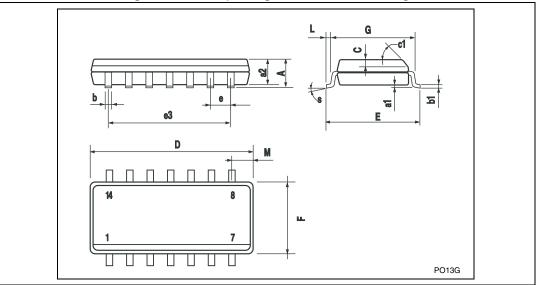
#### Figure 53. TSSOP8 package mechanical drawing

#### Table 14. TSSOP8 package mechanical data

	Dimensions							
Symbol		Millimeters			Inches			
	Min	Тур	Мах	Min	Тур	Мах		
А			1.2			0.047		
A1	0.05		0.15	0.002		0.006		
A2	0.80	1.00	1.05	0.031	0.039	0.041		
b	0.19		0.30	0.007		0.012		
С	0.09		0.20	0.004		0.008		
D	2.90	3.00	3.10	0.114	0.118	0.122		
E	6.20	6.40	6.60	0.244	0.252	0.260		
E1	4.30	4.40	4.50	0.169	0.173	0.177		
е		0.65			0.0256			
К	0 °		8 °	0 °		8 °		
L	0.45	0.60	0.75	0.018	0.024	0.030		
L1		1			0.039			



### 5.4 SO14 package information



#### Figure 54. SO14 package mechanical drawing

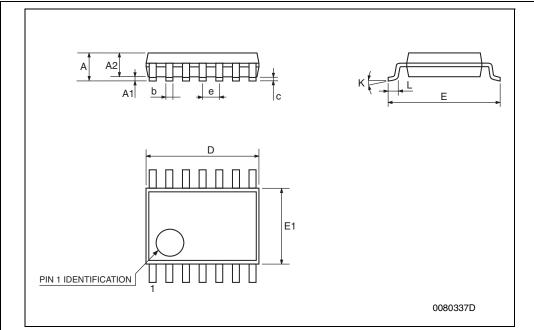
### Table 15. SO14 package mechanical data

	Dimensions								
Symbol		Millimeters			Inches				
	Min	Тур	Max	Min	Тур	Мах			
А			1.75			0.068			
a1	0.1		0.2	0.003		0.007			
a2			1.65			0.064			
b	0.35		0.46	0.013		0.018			
b1	0.19		0.25	0.007		0.010			
С		0.5			0.019				
c1		45 °			45 °				
D	8.55		8.75	0.336		0.344			
E	5.8		6.2	0.228		0.244			
е		1.27			0.050				
e3		7.62			0.300				
F	3.8		4.0	0.149		0.157			
G	4.6		5.3	0.181		0.208			
L	0.5		1.27	0.019		0.050			
М			0.68			0.026			
S			8 °			8 °			



### 5.5 TSSOP14 package information

Figure 55. TSSOP14 package mechanical drawing

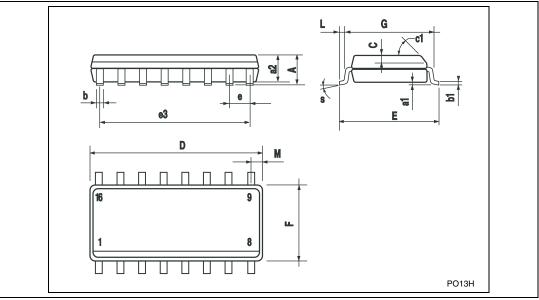


#### Table 16. TSSOP14 package mechanical data

	Dimensions								
Symbol	Millimeters			Inches					
	Min	Тур	Мах	Min	Тур	Max			
А			1.2			0.047			
A1	0.05		0.15	0.002	0.004	0.006			
A2	0.8	1	1.05	0.031	0.039	0.041			
b	0.19		0.30	0.007		0.012			
с	0.09		0.20	0.004		0.0089			
D	4.9	5	5.1	0.193	0.197	0.201			
E	6.2	6.4	6.6	0.244	0.252	0.260			
E1	4.3	4.4	4.48	0.169	0.173	0.176			
е		0.65			0.0256				
К	0 °		8 °	0 °		8 °			
L	0.45	0.60	0.75	0.018	0.024	0.030			



### 5.6 SO16 package information



#### Figure 56. SO16 package mechanical drawing

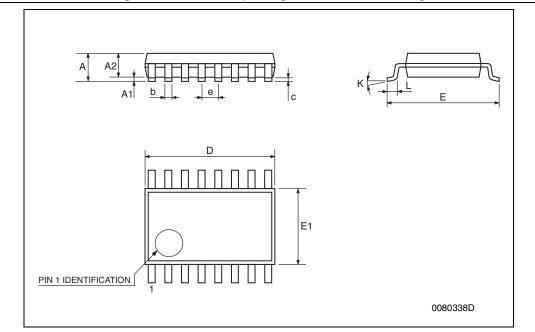
#### Table 17. SO16 package mechanical data

	Dimensions					
Symbol	Millimeters			Inches		
	Min	Тур	Max	Min	Тур	Мах
А			1.75			0.068
a1	0.1		0.2	0.004		0.008
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
С		0.5			0.019	
c1		45 °			45 °	
D	9.8			0.385		0.393
E	5.8		10	0.228		0.244
е		1.27	6.2		0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
М			0.62			0.024
S			8 °			8 °



### 5.7 TSSOP16 package information

Figure 57. TSSOP16 package mechanical drawing



### Table 18. TSSOP16 package mechanical data

	Dimensions					
Symbol	Millimeters			Inches		
	Min	Тур	Мах	Min	Тур	Max
А			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
с	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65			0.0256	
К	0 °		8 °	0 °		8 °
L	0.45	0.60	0.75	0.018	0.024	0.030



## 6 Order information

Part number	Temperature range	Package	Packing	Marking	
TSH70CLT	_	SOT23-5	Tape and reel	K301	
TSH70CD/CDT		803	Tube or tone and real	70C	
TSH71CD/CDT		SO8	Tube or tape and reel	74.0	
TSH71CPT		TSSOP8	Tape and reel	71C	
TSH72CD/CDT		SO8	Tube or tape and reel	700	
TSH72CPT	0 °C to 70 °C	TSSOP8	Tape and reel	72C	
TSH73CD/CDT		SO14	Tube or tape and reel	720	
TSH73CPT		TSSOP14	Tape and reel	73C	
TSH74CD/CDT		SO14	Tube or tape and reel	740	
TSH74CPT	-	TSSOP14	Tape and reel	74C	
TSH75CD/CDT		SO16	Tube or tape and reel	75.0	
TSH75CPT		TSSOP16	Tape and reel	75C	

Table 19. Order codes



# 7 Revision history

Date	Revision	Changes
Nov. 2000	1	First Release.
Aug. 2002	2	Limit min. of I <sub>sink</sub> from 24mA to 20mA (only on 3V power supply). Reason: yield improvement.
May 2006	3	Improvement of VOL max. at 3V and 5V power supply on 150- ohm load connected to GND (pages 6 and 8). Reason: TSH7x can drive video signals from DACs to lines in single supply (3V or 5V) without any DC level change of the video signals. Grammatical and typographical changes throughout. Package mechanical data updated.
05-Dec-2013	4	Updated slew rate in <i>Features</i> <i>Table 12: SOT23-5 package mechanical data</i> : added information for inches.

Table 20.	Document	revision	history
-----------	----------	----------	---------



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



